IPC ASSOCIATION CONNECT ELECTRONICS INDUSTR	Material Compos © Copyright 2005. IPC international and Pan-A	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No. Homogeneous Mater					ials and Mfg Information			
upplier Infor	mation													
Company name*			Company unique ID			Ţ	Unique ID Authority				Response Date*			
nsemi											2024-05-21			
Contact Name		Title - Contact			I	Phone - Contact*				Email - Contact*				
Product-Env-Stev	wards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
uthorized Repre	sentative*	Title - Representative			I	Phone - Representative*				Email - Representative*				
Product-Env-Stev	wards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Reques	ster Item Number	em Number Mfr Item Number Mfr Item N NCV8189CMLADJTC NCV8189 A		Mfr Item Name			Effective Date	e Vers	Yersion Manufacturing Site		7	Weight*	UOM	Unit Type
				NCV8189 AD sle	AD slew rate ADJ DFNW8 3x3		2024-05-21 MY1		MY1	28.2 mg		mg	Each	
Ianufacturing	g Proccess Informatio	on												
Terminal Plating / Grid Array Material Terminal			erminal Base A	nal Base Alloy J-STD-020 MSL Ratin			Peak Process Body Temperature Max Time at Peak				Temperati	ure Numb	per of Reflow Cyc	eles
Matte Tin (Sn) - annealed		CU Alloy 1		1		260	C		30	secono	ds 3			
omments														
vel 1 - maximum	time at peak temperature	e during sol	dering is 10-30	0 seconds										
or more informa	tion regarding material co	mposition	please refer to	page 3										

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have not independently verified and or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.38	mg	Supplier	Silicon (Si)	7440-21-3		0.38	mg
Die Attach	0.07	mg		Epoxy resin	proprietary data		0.0105	mg
			Supplier	Silver (Ag)	7440-22-4		0.056	mg
			Supplier	Bismaleimide	13676-54-5		0.0035	mg
Lead Frame	10.71	mg	Supplier	Silver (Ag)	7440-22-4		0.1834	mg
			Supplier	Tin (Sn)	7440-31-5		0.6417	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0202	mg
			Supplier	Chromium (Cr)	7440-47-3		0.0303	mg
			Supplier	Copper (Cu)	7440-50-8		9.8093	mg
Mold Compound-Black	15.76	mg	Supplier	Silica Amorphous (SiO2)	7631-86-9		1.182	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0788	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		12.5292	mg
			Supplier	EpoxyNovolaCresins (Cresolic)	64425-89-4		0.788	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		1.182	mg
Plating	0.1	mg	Supplier	Tin (Sn)	7440-31-5		0.1	mg
Wire Bond	1.18	mg	Supplier	Palladium (Pd)	7440-05-3		0.0295	mg
			Supplier	Gold (Au)	7440-57-5		0.0118	mg
			Supplier	Copper (Cu)	7440-50-8		1.1387	mg